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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

APPLICABLE STANDARD				
RATING	OPERATING TEMPERATURE RANGE	-30°C TO + 85°C (NOTE 1)	STORAGE TEMPERATURE RANGE	-10°C TO + 60°C (NOTE 3)
	OPERATING HUMIDITY RANGE	40% TO 80% (NOTE 2)	STORAGE HUMIDITY RANGE	40% TO 70% (NOTE 3)
	VOLTAGE	250V AC	APPLICABLE CONNECTOR	DF3-*S-2C
	CURRENT	3A		

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION				
GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X
ELECTRIC CHARACTERISTICS				
CONTACT RESISTANCE	100mA (DC OR 1000 Hz).	30mΩ MAX.	X	—
INSULATION RESISTANCE	500V DC.	1000MΩ MIN.	X	—
VOLTAGE PROOF	650V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	—
MECHANICAL CHARACTERISTICS				
MECHANICAL OPERATION	30 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 30mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
VIBRATION	FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
SHOCK	490 m/s^2 DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		X	–
ENVIRONMENTAL CHARACTERISTICS				
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→ 5 TO 35→+85→ 5 TO 35 °C TIME 30→ 5 MAX → 30→ 5 MAX min UNDER 5 CYCLES.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 1000MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
DAMP HEAT (STEADY STATE)	EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.	① CONTACT RESISTANCE: 30mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.	X	–
RESISTANCE TO SOLDERING HEAT	1) AUTOMATIC SOLDERING (FLOW) SOLDER TEMPERATURE, 260 ℃ FOR IMMERSION,DURATION, 5 sec. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE :300℃, SOLDERING TIME :2sec. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	–
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 230°C FOR INSERTION DURATION, 3sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	–

REMARKS
NOTE 1:INCLUDING THE TEMPERATURE RISE BY CURRENT.
NOTE2:NO CONDENSING.
NOTE3:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD AFTER PCBBOARD , OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERM STORAGE DURING TRANSPORTATION.

	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
⚠0		DIS-H-000745			

Unless otherwise specifid , refer to JIS C 5402.

APPROVED	TY.OMA	06.08.31
CHECKED	HK.UMEHARA	06.08.31
DESIGNED	TS.KUMAZAWA	06.08.29
DRAWN	AK.MIURA	06.08.29

Note QT:Qualification Test AT:Assurance Test X:Applicable Test

DRAWING NO. ELC4-162184-04

HRS	SPECIFICATION SHEET	PART NO.	DF3A-*P-2DSA	
	HIROSE ELECTRIC CO., LTD.	CODE NO.	CL543 ⚠0	1/1

FORM HD0011-2-1